

Lonten N-channel 60V, 83A, 3.6mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using split gate trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- 60V,83A, R_{DS(on),max} =3.6mΩ@V_{GS} = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green device available

Applications

- Motor Drives
- UPS
- DC-DC Converter

Absolute Maximum Ratings Tc = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	60	V
Continuous drain current (Tc = 25°C)	1	83	A
(T _C = 100°C)	ID	60	А
Pulsed drain current ¹⁾	I _{DM}	249	А
Gate-Source voltage	V _{GSS}	±20	V
Avalanche energy ²⁾	Eas	28.8	mJ
Power Dissipation	PD	57	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case	R _{ejC}	2.2	°C/W
Thermal Resistance Junction-to-Ambient	R _{eja}	55	°C/W



LSGN06R036HWB

Package Marking and Ordering Information

Device	Device Package	Marking	Units/Reel	
LSGN06R036HWB	DFN5X6	06R036HW	5000	

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	·	·				
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	60			V
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2.0	3.0	4.0	V
Drain-source leakage current	I _{DSS}	V _{DS} =60 V, V _{GS} =0V			1	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0 V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0 V			-100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10 V, I _D =20 A		2.9	3.6	mΩ
Forward transconductance	g _{fs}	V _{DS} =5V , I _D =20A		66		S
Dynamic characteristics						
Input capacitance	Ciss			3511		
Output capacitance	Coss	$V_{DS} = 30 V, V_{GS} = 0 V,$		1176		pF
Reverse transfer capacitance	C _{rss}	F = 1MHz		67		
Turn-on delay time	t _{d(on)}			20.3		
Rise time	tr	V _{DD} = 30V,V _{GS} =10V, I _D = 20A		9.6		ns
Turn-off delay time	t _{d(off)}	R _σ =3Ω		61		
Fall time	tr			15.2		
Gate resistance	Rg	V _{GS} =0 V,V _{DS} =0 V, F=1MHz		1.1		Ω
Gate charge characteristics						
Gate to source charge	Qgs			15.5		
Gate to drain charge	Qgd	V _{DS} =30V, I _D =20A, V _{GS} = 10 V		9.5		nC
Gate charge total	Qg	- V _{GS} = 10 V		48		
Drain-Source diode characteris	stics and Maxi	mum Ratings				
Continuous Source Current	ls				47.5	A
Pulsed Source Current ³⁾	Іѕм				142.5	Α
Diode Forward Voltage	Vsd	V _{GS} =0V, I _S =20A, T _J =25℃			1.2	V
Reverse recovery time	trr	I _F =20A,dI _F /dt=100 A/µs		24		ns
Reverse recovery charge	Qrr	$1_F = 20A, u_F/u_F = 100 A/\mu S$		85		nC

Notes:

1: Repetitive Rating: Pulse width limited by maximum junction temperature.

2: V_DD=50V, V_Gs=10V, L=0.1mH, I_{AS}=24A, Starting T_J=25 $^\circ\!\!\mathbb{C}.$

3: Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.



LSGN06R036HWB

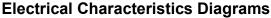
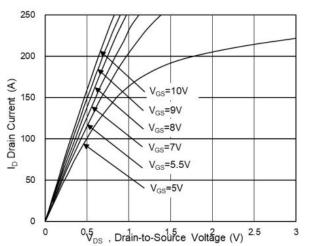
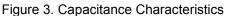
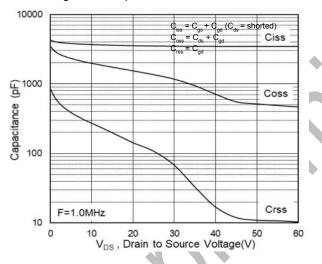
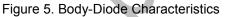


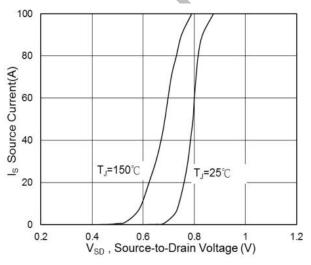
Figure 1. Typ. Output Characteristics











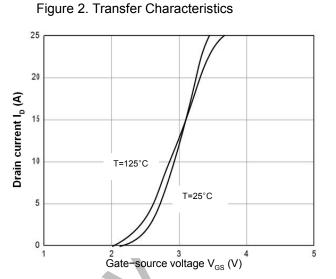
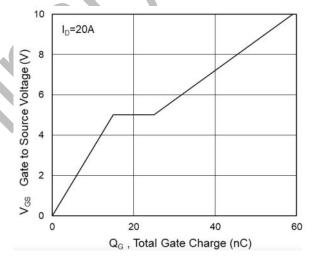
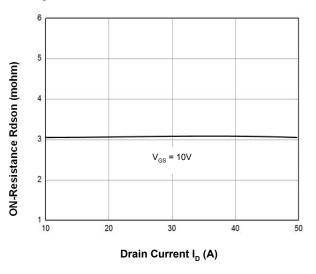


Figure 4. Gate Charge Waveform









2.0

Normalized On Resistance

0.5

-50

0

Figure 7. Rdson-Junction Temperature

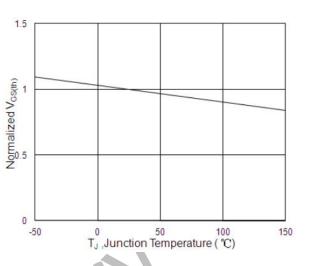
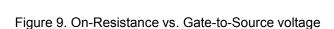


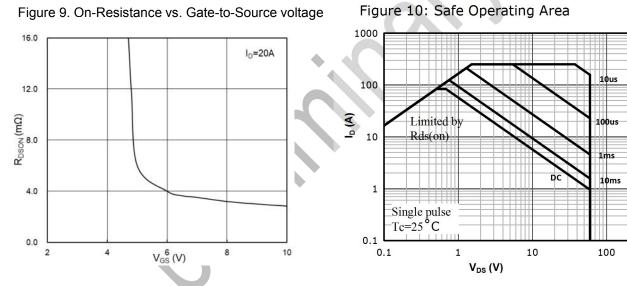
Figure 8. V_{GS(th)}-Junction Temperature



50

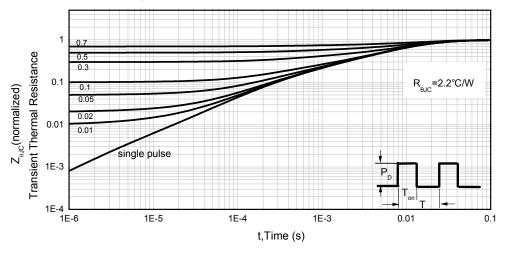
T_J, Junction Temperature (°C)

100



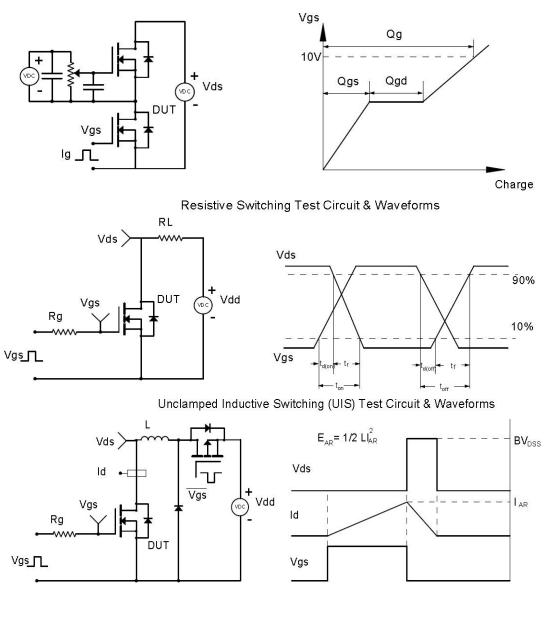
150



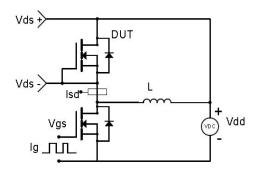


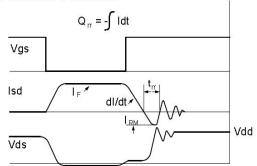
LOYTEN 龙腾 Test Circuit & Waveforms





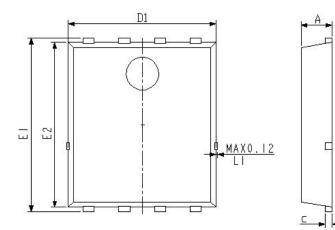
Diode Recovery Test Circuit & Waveforms

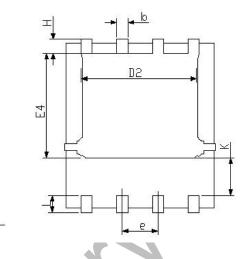






Mechanical Dimensions for DFN5 \times 6





DIMENSIONS		DIMENSIONS IN INCHES		
DIMENSIONS	IN MILLITMETERS		DIMENSIONS	S IN INCHES
SYMBOL	MIN	MAX	MIN	MAX
А	0.85	1.20	0.033	0.047
b	0.30	0.51	0.012	0.020
С	0.15	0.35	0.006	0.014
D1	4.80	5.40	0.189	0.213
D2	3.70	4.55	0.146	0.179
E1	5.95	6. 35	0.234	0.250
E2	5.45	6.06	0.215	0.239
E4	3. 30	3. 92	0.130	0.154
е	1. 27BSC		0. 05BSC	
L	0.3	0.71	0.012	0.028
Н	0.38	0.71	0.015	0.028
K	1.15	1.45	0.045	0.057



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